# International Rectifier

### IRF7509PbF

#### HEXFET® Power MOSFET

- Generation V Technology
- Ultra Low On-Resistance
- Dual N and P Channel MOSFET
- Very Small SOIC Package
- Low Profile (<1.1mm)
- Available in Tape & Reel
- Fast Switching
- Lead-Free

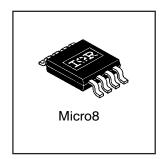
### 

|                     | N-Ch  | P-Ch  |
|---------------------|-------|-------|
| V <sub>DSS</sub>    | 30V   | -30V  |
| R <sub>DS(on)</sub> | 0.11Ω | 0.20Ω |

#### **Description**

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The new Micro8 package, with half the footprint area of the standard SO-8, provides the smallest footprint available in an SOIC outline. This makes the Micro8 an ideal device for applications where printed circuit board space is at a premium. The low profile (<1.1mm) of the Micro8 will allow it to fit easily into extremely thin application environments such as portable electronics and PCMCIA cards.



#### **Absolute Maximum Ratings**

|  | Parameter                                   | Ma                              | Units     |      |
|--|---|---------------------------------|-----------|------|
|  |   | N-Channel                       | P-Channel |      |
| $V_{DS}$                               | Drain-Source Voltage                        | 30                              | -30       | V    |
| I <sub>D</sub> @ T <sub>A</sub> = 25°C | Continuous Drain Current, V <sub>GS</sub>   | 2.7                             | -2.0      |      |
| I <sub>D</sub> @ T <sub>A</sub> = 70°C | Continuous Drain Current, V <sub>GS</sub>   | 2.1                             | -1.6      | A    |
| I <sub>DM</sub>                        | Pulsed Drain Current <sup>⊕</sup>           | 21                              | -16       |      |
| P <sub>D</sub> @T <sub>A</sub> = 25°C  | Maximum Power Dissipation⊕                  | 1.2                             | W         |      |
| P <sub>D</sub> @T <sub>A</sub> = 70°C  | Maximum Power Dissipation⊕                  | 0.8                             | W         |      |
|  | Linear Derating Factor                      | 10                              | mW/°C     |      |
| $V_{GS}$                               | Gate-to-Source Voltage ± 20                 |                                 | 20        | V    |
| $V_{GSM}$                              | Gate-to-Source Voltage Single Pulse tp<10μS | Voltage Single Pulse tp<10μS 30 |           | V    |
| dv/dt                                  | Peak Diode Recovery dv/dt ②                 | dv/dt ② 5.0                     |           | V/ns |
| T <sub>J</sub> , T <sub>STG</sub>      | Junction and Storage Temperature Range      | -55 to + 150                    |           | °C   |
|  | Soldering Temperature, for 10 seconds       | 240 (1.6mm                      |           |      |

#### **Thermal Resistance**

|                 | Parameter                     | Max. | Units |
|-----------------|-------------------------------|------|-------|
| $R_{\theta JA}$ | Maximum Junction-to-Ambient ④ | 100  | °C/W  |

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Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

| Electrical           | car Characteristics @ 1 <sub>J</sub> - 25 C (unless otherwise specified) |              |      |        |          |       | e specified)  |
|----------------------|--|--------------|------|--------|----------|-------|---|
|                      | Parameter  |              |      | Тур.   | Max.     | Units |   |
| V <sub>(BR)DSS</sub> | Drain-to-Source Breakdown Voltage  | N-Ch         | 30   | _      | _        | V     | $V_{GS} = 0V, I_D = 250\mu A$   |
| (BR)DSS              | Diam-to-course Breakdown Voltage   |              | -30  | _      | _        | V     | $V_{GS} = 0V, I_D = -250\mu A$  |
| ΔV:==:==/ΔΤ.         | Breakdown Voltage Temp. Coefficient                                      |              | —    | 0.059  |          | v/°c  | Reference to 25°C, I <sub>D</sub> = 1mA                                     |
| A V (BR)DSS/A I J    | breakdown voltage remp. Odemolent  | P-Ch         | _    | -0.039 | <b>—</b> | V/ C  | Reference to 25°C, I <sub>D</sub> = -1mA                                    |
|                      |  | N-Ch         | T —  | 0.09   | 0.110    |       | V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.7A ④                              |
| R <sub>DS(ON)</sub>  | Static Drain-to-Source On-Resistance                                     | IN-CII       | _    | 0.14   | 0.175    | Ω     | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 0.85A ④                            |
| INDS(ON)             | Static Diam-to-Source On-itesistance                                     | P-Ch         | -    | 0.17   | 0.20     | 72    | V <sub>GS</sub> = -10V, I <sub>D</sub> =-1.2A ⊕                             |
|                      |  | 1 -011       | _    | 0.30   | 0.40     | 1     | V <sub>GS</sub> = -4.5V, I <sub>D</sub> =-0.6A ⊕                            |
| V <sub>GS(th)</sub>  | Gate Threshold Voltage   | N-Ch         | 1.0  | _      | _        | V     | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$  |
| V GS(th)             | Cate Tilleshold Voltage  | P-Ch         | -1.0 | _      | _        | V     | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA                 |
| a.                   | Forward Transconductance   | N-Ch         |      |        | _        | s     | V <sub>DS</sub> = 10V, I <sub>D</sub> = 0.85A ④                             |
| 9 <sub>fs</sub>      | 1 orward Transconductance  | P-Ch         | 0.92 | _      |          | ಿ     | $V_{DS} = -10V, I_{D} = -0.6A$ (4)  |
|                      |  | N-Ch         |      | _      | 1.0      |       | $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$                               |
| I <sub>DSS</sub>     | Drain-to-Source Leakage Current  | P-Ch         | _    |        | -1.0     |       | $V_{DS} = -24V, V_{GS} = 0V$  |
| IDSS                 |  | N-Ch         | _    | _      | 25       | μA    | $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ |
|                      |  | P-Ch         |      | _      | -25      |       | $V_{DS} = -24V, V_{GS} = 0V, T_{J} = 125^{\circ}C$                          |
| I <sub>GSS</sub>     | Gate-to-Source Forward Leakage   | N-P          |      | _      | ±100     |       | V <sub>GS</sub> = ± 20V   |
| $Q_{\alpha}$         | Total Gate Charge  | N-Ch         | _    | 7.8    | 12       |       | N-Channel   |
| <b>~</b> g           | Total Gate Gliarge   | P-Ch         | _    | 7.5    |          |       | I <sub>D</sub> = 1.7A, V <sub>DS</sub> = 24V, V <sub>GS</sub> = 10V         |
| Q <sub>qs</sub>      | Gate-to-Source Charge  | N-Ch         |      | 1.2    | +        | nC    | 1D - 1.7A, VDS - 24V, VGS - 10V   |
| gs                   | - Care to Course Criange   | P-Ch         | _    | 1.3    | 1.9      | 110   | P-Channel   |
| $Q_{qd}$             | Gate-to-Drain ("Miller") Charge  | N-Ch         |      | 2.5    | 3.8      |       | I <sub>D</sub> = -1.2A, V <sub>DS</sub> = -24V, V <sub>GS</sub> = -10V      |
| <b>~</b> ga          | Sate to Brain ( Willier ) Sharge   | P-Ch         |      | 2.5    | 3.7      |       | ID = -1.2A, VDS = -24V, VGS = -10V  |
| t <sub>d(on)</sub>   | Turn-On Delay Time   |              |      | 4.7    |          |       | N-Channel   |
| -u(OII)              |  | P-Ch         | _    | 9.7    | _        |       | $V_{DD} = 15V$ , $I_D = 1.7A$ , $R_G = 6.1\Omega$ ,                         |
| t <sub>r</sub>       | Rise Time  | N-Ch         | _    | 10     |          |       | $R_D = 8.7\Omega$   |
| 1                    |  | P-Ch         |      | 12     |          | ns    | (4)   |
| $t_{d(off)}$         | Turn-Off Delay Time  | N-Ch         |      | 12     |          | 113   | P-Channel   |
| u(OII)               | ,  | P-Ch         |      | 19     |          |       | $V_{DD} = -15V$ , $I_D = -1.2A$ , $R_G = 6.2\Omega$ ,                       |
| t <sub>f</sub>       | Fall Time  | N-Ch         | _    | 5.3    | _        |       | $R_{D} = 12\Omega$  |
| •                    |  | P-Ch         | -    | 9.3    |          |       | · · · · · - · · · · · · · · · · · · · ·                                     |
| C <sub>iss</sub>     | Input Capacitance Output Capacitance                                     | N-Ch         |      | 210    |          |       | N-Channel   |
| 133                  |  | P-Ch         |      | 180    |          |       | $V_{GS} = 0V, V_{DS} = 25V, f = 1.0MHz$                                     |
| Coss                 |  | N-Ch         |      | 80     |          | pF    | 3   |
|                      |  | P-Ch         |      | 87     |          |       | P-Channel   |
| C <sub>rss</sub>     | Reverse Transfer Capacitance   | N-Ch<br>P-Ch | _    | 32     | _        |       | $V_{GS} = 0V, V_{DS} = -25V, f = 1.0MHz$                                    |
| -188                 |  |              | —    | 42     | —        |       | 30 , 103 =-1, 1   |

### Source-Drain Ratings and Characteristics

|                 | Parameter                              |      | Min. | Тур. | Max.  | Units | Conditions   |
|-----------------|--|------|------|------|-------|-------|--|
|                 |  | N-Ch | l —  | _    | 1.25  |       |  |
| IS              | Continuous Source Current (Body Diode) | P-Ch | _    | _    | -1.25 | Α     |  |
|                 |  | N-Ch | _    | _    | 21    | ^     |  |
| I <sub>SM</sub> | Pulsed Source Current (Body Diode) ①   | P-Ch | _    | _    | -16   | ]     |  |
| \ /             | D: 1 E 1)/ II                          | N-Ch | —    | _    | 1.2   | V     | $T_J = 25$ °C, $I_S = 1.7A$ , $V_{GS} = 0V$ ③        |
| V <sub>SD</sub> | Diode Forward Voltage                  | P-Ch | _    | _    | -1.2  | •     | $T_J = 25$ °C, $I_S = -1.8A$ , $V_{GS} = 0V$ ③       |
|                 | D                                      | N-Ch | _    | 40   | 60    | ns    | N-Channel  |
| ι <sub>rr</sub> | Reverse Recovery Time                  | P-Ch | _    | 30   | 45    | '''3  | $T_J = 25$ °C, $I_F = 1.7A$ , di/dt = 100A/ $\mu$ s  |
| Q <sub>rr</sub> | Bayerea Bassyany Charma                | N-Ch | _    | 48   | 72    | nC    | P-Channel 3  |
|                 | Reverse Recovery Charge                | P-Ch | _    | 37   | 55    |       | $T_J = 25$ °C, $I_F = -1.2A$ , $di/dt = -100A/\mu s$ |

#### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 21 )
- ② N-Channel I<sub>SD</sub>  $\leq$  1.7A, di/dt  $\leq$  120A/ $\mu$ s, V<sub>DD</sub>  $\leq$  V<sub>(BR)DSS</sub>, T<sub>J</sub>  $\leq$  150°C P-Channel I<sub>SD</sub>  $\leq$  -1.2A, di/dt  $\leq$  160A/ $\mu$ s, V<sub>DD</sub>  $\leq$  V<sub>(BR)DSS</sub>, T<sub>J</sub>  $\leq$  150°C
- $\center{3}$  Pulse width  $\le 300 \mu s$ ; duty cycle  $\le 2\%$ .
- 4 Surface mounted on FR-4 board,  $t \leq 10 sec.$

# International TOR Rectifier

#### N - Channel

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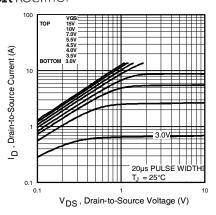


Fig 1. Typical Output Characteristics

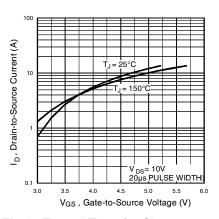


Fig 3. Typical Transfer Characteristics

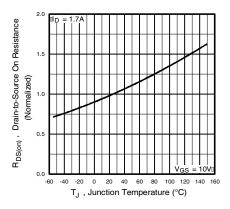


Fig 5. Normalized On-Resistance Vs. Temperature www.irf.com

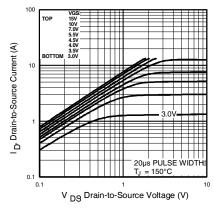
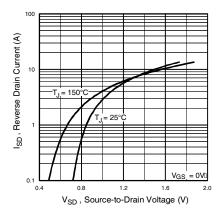


Fig 2. Typical Output Characteristics



**Fig 4.** Typical Source-Drain Diode Forward Voltage

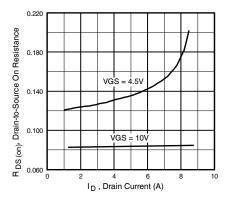


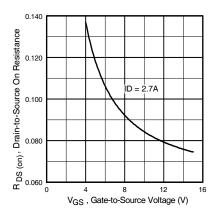
Fig 6. Typical On-Resistance Vs. Drain Current

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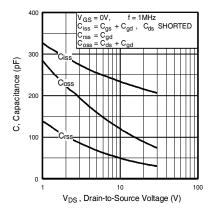
TOR Rectifier

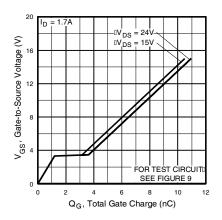




**Fig 7.** Typical On-Resistance Vs. Gate Voltage

Fig 8. Maximum Safe Operating Area





**Fig 9.** Typical Capacitance Vs. Drain-to-Source Voltage

**Fig 10.** Typical Gate Charge Vs. Gate-to-Source Voltage

## International TOR Rectifier

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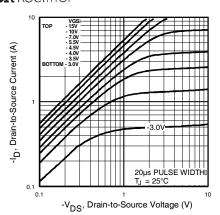


Fig 11. Typical Output Characteristics

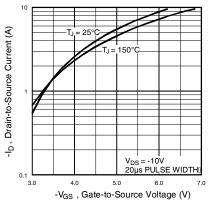
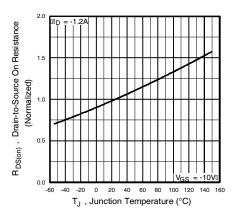


Fig 13. Typical Transfer Characteristics



**Fig 15.** Normalized On-Resistance Vs. Temperature

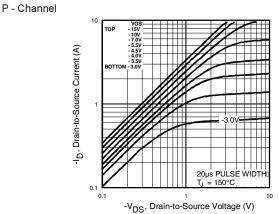
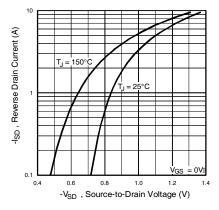


Fig 12. Typical Output Characteristics



**Fig 14.** Typical Source-Drain Diode Forward Voltage

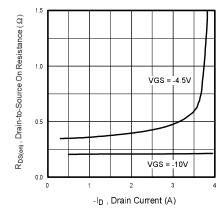
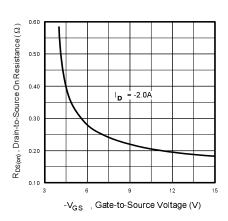


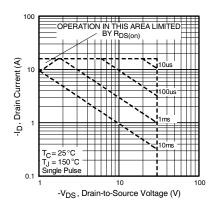
Fig 16. Typical On-Resistance Vs. Drain Current

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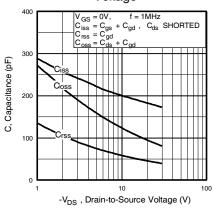


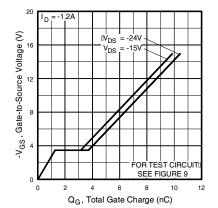
P - Channel



**Fig 17.** Typical On-Resistance Vs. Gate Voltage

Fig 18. Maximum Safe Operating Area





**Fig 19.** Typical Capacitance Vs. Drain-to-Source Voltage

**Fig 20.** Typical Gate Charge Vs. Gate-to-Source Voltage

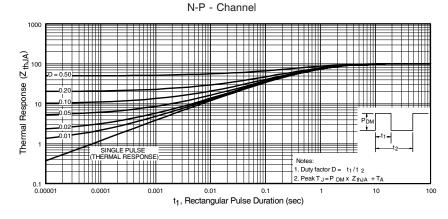
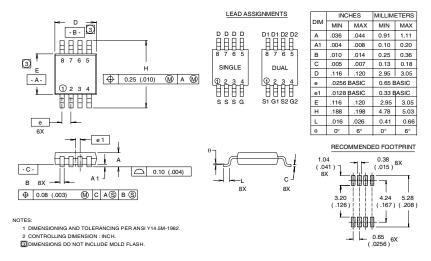


Fig 21. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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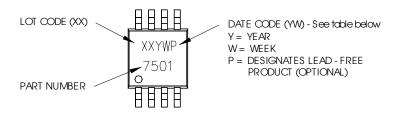
### Micro8 Package Outline

Dimensions are shown in milimeters (inches)



### Micro8 Part Marking Information

EXAMPLE: THIS IS AN IRF7501



WW = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR

WORK WEEK YE AR 2001 01 02 A B 2002 2003 03 2004 2005 04 D 2006 2007 2008 2009 24 25 26

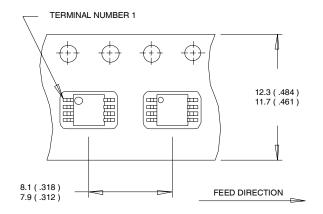
WW = (27-52) IF PRECEDED BY A LETTER

| YEAR | Υ | WORK<br>WEEK | W |
|------|---|--------------|---|
| 2001 | Α | 27           | A |
| 2002 | В | 28           | В |
| 2003 | С | 29           | С |
| 2004 | D | 30           | D |
| 2005 | Е | 1            | 1 |
| 2006 | F |              |   |
| 2007 | G |              |   |
| 2008 | Н | 1            | 1 |
| 2009 | J | 7            | 1 |
| 2010 | K | 50           | Χ |
|      |   | 51           | Υ |
|      |   | 52           | Z |

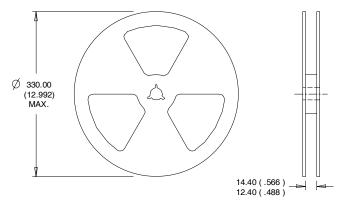
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### Micro8 Tape & Reel Information

Dimensions are shown in millimeters (inches)



- NOTES:
  1. OUTLINE CONFORMS TO EIA-481 & EIA-541.
  2. CONTROLLING DIMENSION : MILLIMETER.



- 1. CONTROLLING DIMENSION : MILLIMETER. 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice. This product has been designed and qualified for the Consumer market. Qualification Standards can be found on IR's Web site.



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